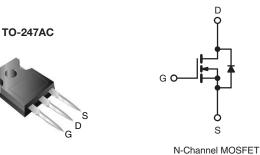


## **Vishay Siliconix**

## **Power MOSFET**

PRODUCT SUMMA	RY			
V <sub>DS</sub> (V)	600			
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 10 V$	0.24		
Q <sub>g</sub> (Max.) (nC)	150	)		
Q <sub>gs</sub> (nC)	45			
Q <sub>gd</sub> (nC)	76			
Configuration	Single			



### FEATURES

• Low Gate Charge Q<sub>g</sub> Results in Simple Drive Requirement



- Improved Gate, Avalanche and Dynamic dV/dt Ruggedness
  COMPLIANT
- Fully Characterized Capacitance and Avalanche Voltage and Current
- Enhanced Body Diode dV/dt Capability
- Compliant to RoHS Directive 2002/95/EC

### BENEFITS

- Hard Switching Primary or PFS Switch
- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching
- Motor Drive

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFP22N60KPbF
Lead (Fb)-liee	SiHFP22N60K-E3
SnPb	IRFP22N60K
	SiHFP22N60K

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> :	= 25 °C, unless otherwi	se noted)		
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	600	v
Gate-Source Voltage	V <sub>GS</sub>	± 30	v	
Continuous Drain Current	$V_{GS}$ at 10 V $T_C = 25 \degree C$	1_	22	
Continuous Drain Current	$T_{\rm C} = 100 ^{\circ}{\rm C}$	- I <sub>D</sub>	14	А
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	88	
Linear Derating Factor			2.9	W/°C
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	380	mJ
Repetitive Avalanche Current <sup>a</sup>		I <sub>AR</sub>	22	A
Repetitive Avalanche Energy <sup>a</sup>		E <sub>AR</sub>	37	mJ
Maximum Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$		PD	370	W
Peak Diode Recovery dV/dt <sup>c</sup>		dV/dt	15	V/ns
Operating Junction and Storage Temperature Range	Э	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C
Soldering Recommendations (Peak Temperature)	for 10 s		300 <sup>d</sup>	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Starting  $T_J$  = 25 °C, L = 1.5 mH,  $R_g$  = 25  $\Omega,$   $I_{AS}$  = 22 A (see fig. 12).

c.  $I_{SD} \leq 22$  A,  $dI/dt \leq 360$  A/µs,  $V_{DD} \leq V_{DS}, \, T_J \leq 150 \ ^{\circ}C.$ 

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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# Vishay Siliconix



THERMAL RESISTANCE RATI	NGS	1				i		
PARAMETER	SYMBOL	TYP	•	MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		40				
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24	Ļ	-			°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-		0.34				
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	TES		ONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	50 µA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I	<sub>D</sub> = 1 mA <sup>d</sup>	-	0.30	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	50 µA	3.0	-	5.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 30 \	/	-	-	± 100	nA
		V <sub>DS</sub> =	= 600 V, V <sub>GS</sub>	= 0 V	-	-	50	
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 480 V	/, V <sub>GS</sub> = 0 V,	T <sub>J</sub> = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub>	= 13 A <sup>b</sup>	-	0.240	0.280	Ω
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> :	= 50 V, I <sub>D</sub> =	13 A <sup>b</sup>	11	-	-	S
Dynamic		•						
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,		-	3570	-	
Output Capacitance	C <sub>oss</sub>		$V_{DS} = 25 V,$		-	350	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	.0 MHz, see	fig. 5	-	36	-	pF
			V <sub>DS</sub> = 1.0	V , f = 1.0 MHz	-	4710	-	p⊦
Output Capacitance	Coss	$V_{GS} = 0 V$	V <sub>DS</sub> = 480	V , f = 1.0 MHz	-	92	-	
Effective Output Capacitance	C <sub>oss</sub> eff.		$V_{DS} = 0$	0 V to 480 V	-	180	-	
Total Gate Charge	Qg				-	-	150	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		, V <sub>DS</sub> = 480 V . 6 and 13 <sup>b</sup>	-	-	45	nC
Gate-Drain Charge	Q <sub>gd</sub>		See lig	. o anu 15	-	-	76	
Turn-On Delay Time	t <sub>d(on)</sub>				-	26	-	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	= 300 V, I <sub>D</sub> =	22 A,	-	99	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	R <sub>g</sub> =	6.2, V <sub>GS</sub> = <sup>-</sup> see fig. 10 <sup>b</sup>		-	48	-	ns
Fall Time	t <sub>f</sub>		see lig. 10-		-	37	-	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym showing the	bol		-	-	22	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral revers p - n junction			-	-	88	A
Body Diode Voltage	V <sub>SD</sub>	T.I = 25 °C	, I <sub>S</sub> = 22 A,	$V_{GS} = 0 V^{b}$	-	_	1.5	v
, ,	- 00	T <sub>.1</sub> = 25 °C	,		-	590	890	-
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 125 °C	le le	= 22 A,	-	670	1010	ns
		T <sub>J</sub> = 25 °C		= 100 A/µs <sup>b</sup>	-	7.2	11	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	T <sub>J</sub> =1 25 °C	1		-	8.5	13	μC
Reverse Recovery Current	I <sub>RRM</sub>		T <sub>J</sub> = 25 °C		-	26	39	
Forward Turn-On Time	t <sub>on</sub>	Intrineio tu	-	s negligible (turn	on is dor			L_)

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$ 

c.  $C_{oss}$  eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

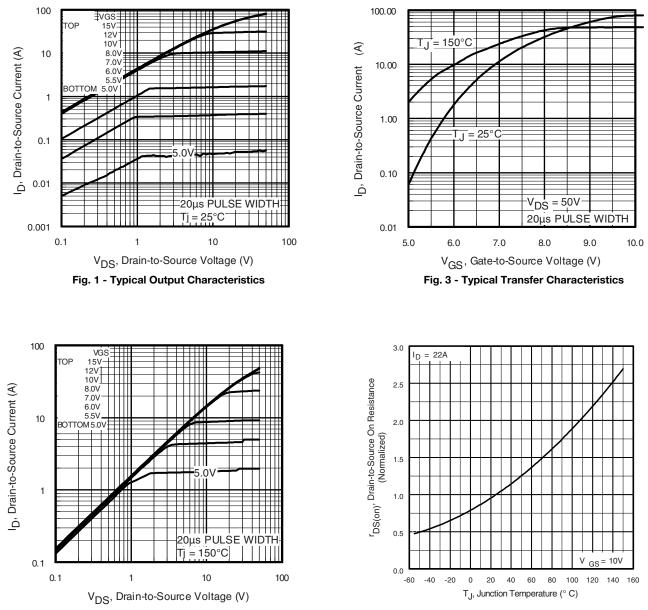
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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 2 - Typical Output Characteristics

Fig. 4 - Normalized On-Resistance vs. Temperature

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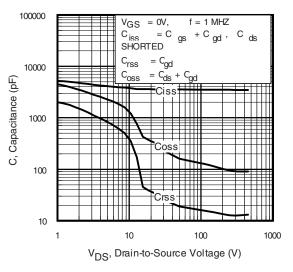


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

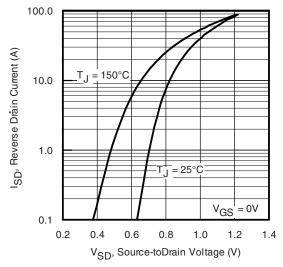


Fig. 7 - Typical Source-Drain Diode Forward Voltage

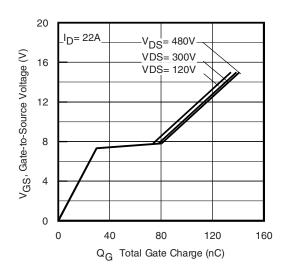


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

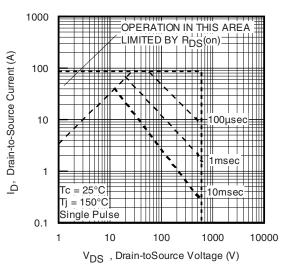


Fig. 8 - Maximum Safe Operating Area

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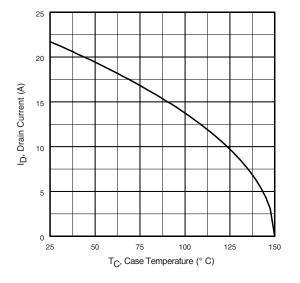


Fig. 9 - Maximum Drain Current vs. Case Temperature

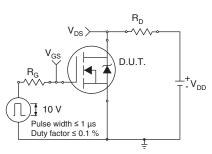


Fig. 10a - Switching Time Test Circuit

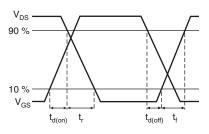


Fig. 10b - Switching Time Waveforms

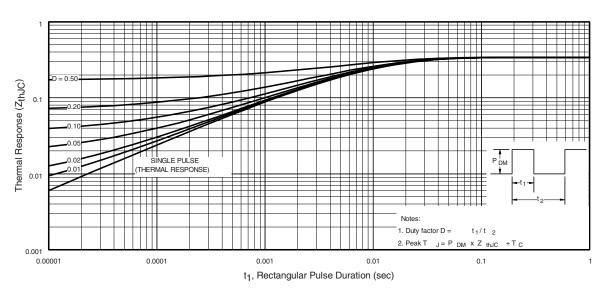


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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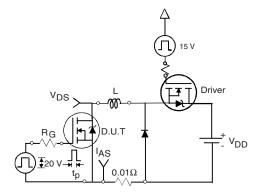


Fig. 12a - Unclamped Inductive Test Circuit

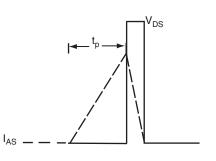


Fig. 12b - Unclamped Inductive Waveforms

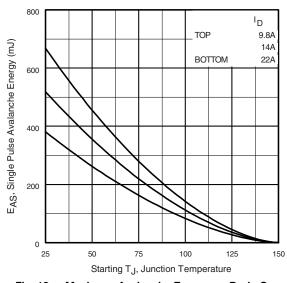
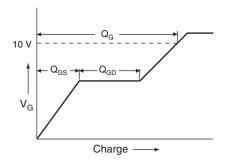
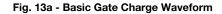


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





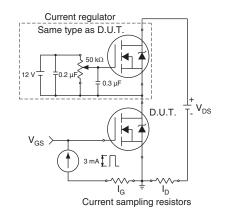


Fig. 13b - Gate Charge Test Circuit

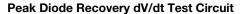
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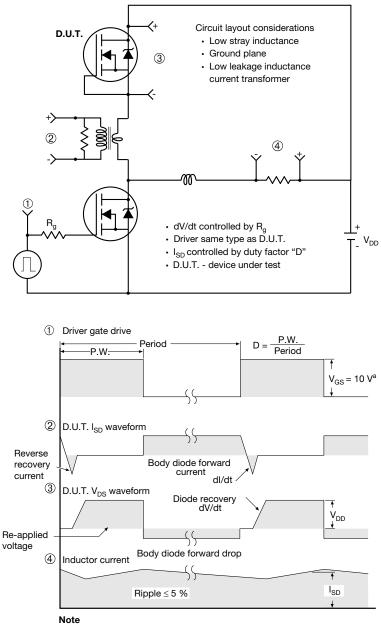
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a. V<sub>GS</sub> = 5 V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?91208">www.vishay.com/ppg?91208</a>.

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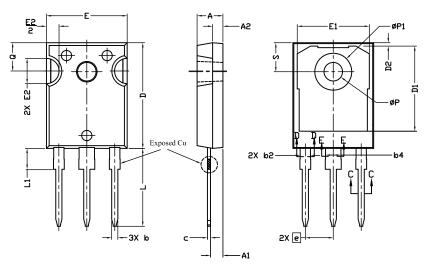
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Vishay Siliconix

# TO-247AC (High Voltage)

## VERSION 1: FACILITY CODE = 9





Section C--C, D--D, E--E

	<i>\</i>

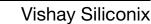
	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
А	4.83	5.21	
A1	2.29	2.55	
A2	1.50	2.49	
b	1.12	1.33	
b1	1.12	1.28	
b2	1.91	2.39	6
b3	1.91	2.34	
b4	2.87	3.22	6, 8
b5	2.87	3.18	
С	0.55	0.69	6
c1	0.55	0.65	
D	20.40	20.70	4

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
D1	16.25	16.85	5
D2	0.56	0.76	
E	15.50	15.87	4
E1	13.46	14.16	5
E2	4.52	5.49	3
е	5.44	BSC	
L	14.90	15.40	
L1	3.96	4.16	6
ØP	3.56	3.65	7
Ø P1	7.19	7.19 ref.	
Q	5.31	5.69	
S	5.54	5.74	

#### Notes

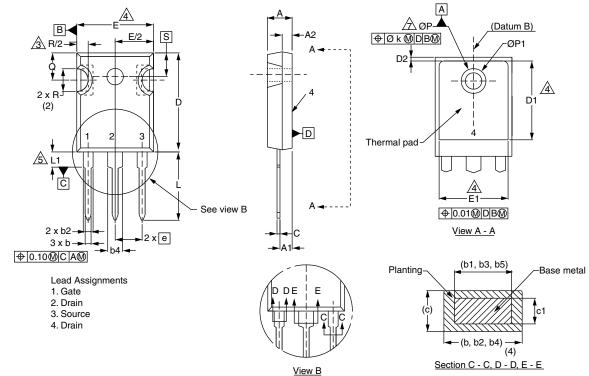
- <sup>(1)</sup> Package reference: JEDEC<sup>®</sup> TO247, variation AC
- (2) All dimensions are in mm
- <sup>(3)</sup> Slot required, notch may be rounded
- <sup>(4)</sup> Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- <sup>(5)</sup> Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- (7) Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition

Revision: 19-Oct-2020





### VERSION 2: FACILITY CODE = Y



	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
А	4.58	5.31	
A1	2.21	2.59	
A2	1.17	2.49	
b	0.99	1.40	
b1	0.99	1.35	
b2	1.53	2.39	
b3	1.65	2.37	
b4	2.42	3.43	
b5	2.59	3.38	
с	0.38	0.86	
c1	0.38	0.76	
D	19.71	20.82	
D1	13.08	-	

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
D2	0.51	1.30	
E	15.29	15.87	
E1	13.72	-	
е	5.46	BSC	
Øk	0.2	254	
L	14.20	16.25	
L1	3.71	4.29	
ØР	3.51	3.66	
Ø P1	-	7.39	
Q	5.31	5.69	
R	4.52	5.49	
S	5.51	BSC	

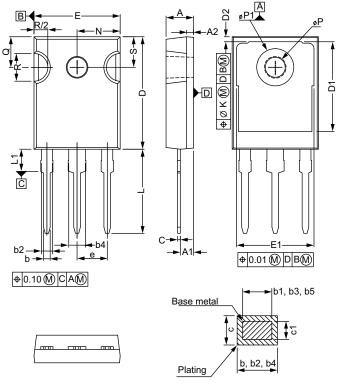
#### Notes

- <sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994
- <sup>(2)</sup> Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- <sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1
- <sup>(5)</sup> Lead finish uncontrolled in L1
- <sup>(6)</sup> Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- <sup>(7)</sup> Outline conforms to JEDEC outline TO-247 with exception of dimension c



**Vishay Siliconix** 

## VERSION 3: FACILITY CODE = N



	MILLIN	IETERS		MILLIN	IETERS
DIM.	MIN.	MAX.	DIM.	MIN.	MAX.
А	4.65	5.31	D2	0.51	1.35
A1	2.21	2.59	E	15.29	15.87
A2	1.17	1.37	E1	13.46	-
b	0.99	1.40	e	5.46	BSC
b1	0.99	1.35	k	0.2	254
b2	1.65	2.39	L	14.20	16.10
b3	1.65	2.34	L1	3.71	4.29
b4	2.59	3.43	N	7.62	BSC
b5	2.59	3.38	Р	3.56	3.66
С	0.38	0.89	P1	-	7.39
c1	0.38	0.84	Q	5.31	5.69
D	19.71	20.70	R	4.52	5.49
D1	13.08	-	S	5.51	BSC

Notes

<sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994

<sup>(2)</sup> Contour of slot optional

<sup>(3)</sup> Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

<sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1

<sup>(5)</sup> Lead finish uncontrolled in L1

<sup>(6)</sup> Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

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